## GREATER IOWA CITY AREA HOME BUILDERS ASSOCIATION 2018 Scholarship Application

PART I – Basic Inf	ormation:		
Name:		Date of Birth:	
Address:		City/State/Zip:	
Phone:		Parent(s) Name:	
		Parent(s) Employer:	
<b>School Currently Attend</b>	ling & Classification	(Jr / Sr / 1st Yr, etc.):	
GPA:			
Educational Goals: (Nan College Name: Address, City, Sta College Phone Nu College Student I Date of Enrollme Anticipated Grad Course of Study:	ate, Zip: nmber: D #: nt: luation Date: (list your major / mino		
Work History / Work Ex	xperience:		
<u>Company</u> 1. 2. 3.	Town & State	Job Duties	Employment Dates
Volunteer Experience:			
Organization 1.	Town & State	<u>Duties</u>	Volunteer Dates
2.			
3.			

## PART II – Written Essays (not short answer)

## Essay: Please attach a maximum 150 word essay on each of these topics:

- 1. What are your career goals?
- 2. What is your background or involvement in the home building industry and related trades?
- 3. What role do you think the home building industry plays in the economy of Iowa?
- 4. What is your financial need for this scholarship?

## **Application Directions and Requirements:**

- 1. Download application in either Word or PDF/Adobe document.
- 2. Type entire application.
- 3. Part I must be entirely completed.
- 4. Part II all essays must be answered.
- 5. Save completed application as a Word or PDF/Adobe document.
- 6. Email completed application and a copy of transcript to Karyl@HBAofIC.org
- 7. TRANSCRIPT REQUIREMENTS:
  - Email 1 copy of transcript to Karyl@HBAofIC.org
  - Mail 1 **OFFICIAL TRANSCRIPT** via US Postal Service to: **Greater Iowa City Area Home Builders Association,**

r Iowa City Area Home Builders Association, PO Box 3396, Iowa City IA 52244

NOTE: Official transcript must be received by April 16, 2018 deadline.

• NOTE: If you are a first semester college student, you must submit **official** final high school transcripts and **official** college transcripts.

The original seal on the official transcript must be in place, not broken, when received by the IC Area HBA office.

8. Deadline: April 16, 2018 for <u>ALL</u> Materials ~ No Exceptions.